Specifications			FX3G-14M	FX3G-24M	FX3G-40M	FX3G-60M
I/O points			256 total (combined local and CC-Link remote I/O)			
Address range			Max. 128 direct addressing and max. 128 remote I/O			
Power supply			100-240 V AC (+10 % / -15 %), 50/60 Hz			
Program memory			32,000 steps EEPROM (internal), exchangeable EEPROM memory cassette with loader function			
Instruction Time			0.21 μs or 0.42 μs / contact instruction			
Integrated inputs	Number of inputs		8	14	24	36
•	Input signal voltage		24 V DC (+/-10 %)			
Input form Response time			sink/source			
		nse time	Approx. 10 ms			
	Isolation		Photocoupler isolation			
Integrated outputs	Number of outputs		6	10	16	48
·	Switching voltage		<240 V AC, <30 V DC (relay output), 5 – 30 V DC (transistor output)			
	Output type/form		Relay or transistor			
	Max. load	resistive	2A/point, max. 8 A total (relay), 0.5 A/point; max. 0.8 A for 4 output points/common terminal (transistor)			
	inductive		80 VA (relay), 12 W/point (at 24 V DC); max. 19.2 W for 4 output points/common terminal (transistor)			
Response time			10 ms (relay), < 5 μs (for Y000 and Y001) / 0.2 ms (for all other outputs) (transistor) (The 40 and 60 I/O point transistor output base units have a 5μs response time for Y002)			
Isolation			Photocoupler isolation			
High-speed counters			21 total, with 16 1-phase (C235 - C250) and 5 2-phase (C251 - C255)			
High-speed outputs			-2,147,483,648 to 2,147,483,647			
24V DC service power supply			400 mA			
Environment			0 – 55 °C ambient temperature; 5 – 95 % relative humidity			